

## SECTION II—CLAIMS

- 1.-28. (Canceled)
29. (Currently Amended) A micro resonator comprising:
- ~~an oscillator member disposed upon an oscillator pedestal; and~~
- ~~an ablative structure positioned on the oscillator member, the ablative structure being separated from the oscillator member by a protective pad.~~
- an ablative structure disposed on the vibrating portion, the ablative structure comprising a pattern of spaced-apart stacks, each spaced-apart stack being separated from the oscillator member by a protective pad.
30. (Previously Presented) The micro resonator according to claim 29 wherein the protective pad is made from aluminum, an aluminum alloy, silver, a silver alloy, indium, or an indium alloy.
31. (Canceled)
32. (Previously Presented) The micro resonator according to claim 29 wherein the protective pad is made from a refractory metal, a refractory metal oxide, a refractory metal silicide, a refractory metal nitride, or combinations thereof.

33. (Previously Presented) The micro resonator according to claim 29 wherein the oscillator member is made of a material selected from polysilicon, a metal, a metal nitride, a metal oxide, a metal silicide, or combinations thereof.

34. (Currently Amended) A microresonator system comprising:

a microresonator having an input and an output and comprising:

an oscillator member comprising a vibrating portion suspended above a substrate by ~~an oscillator~~ a pedestal,

a drive electrode positioned between the ~~oscillator member~~ vibrating portion and the substrate,

~~an ablative structure positioned on the oscillator member, the ablative structure being separated from the oscillator member by a protective pad;~~

an ablative structure disposed on the vibrating portion, the ablative structure comprising a pattern of spaced-apart stacks, each spaced-apart stack being separated from the oscillator member by a protective pad;

an input circuit connected to the input; and

an output circuit connected to the output.

35. (Previously Presented) The micro resonator according to claim 34 wherein the protective pad is made from aluminum, an aluminum alloy, silver, a silver alloy, indium, or an indium alloy.
36. (Canceled)
37. (Previously Presented) The micro resonator according to claim 34 wherein the protective pad is made from a refractory metal, a refractory metal oxide, a refractory metal silicide, a refractory metal nitride, or combinations thereof.
38. (Previously Presented) The micro resonator according to claim 34 wherein the oscillator member is made of a material selected from polysilicon, a metal, a metal nitride, a metal oxide, a metal silicide, or combinations thereof.